

**22NM50**

Preliminary

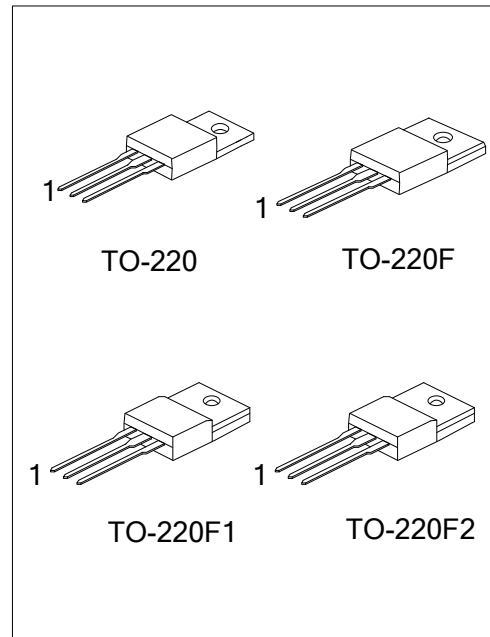
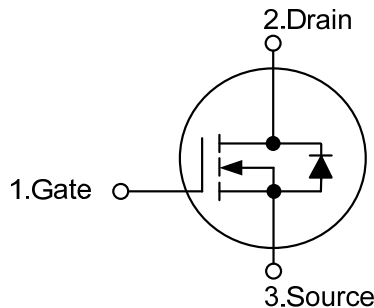
Power MOSFET

**22A, 500V N-CHANNEL
SUPER-JUNCTION MOSFET****DESCRIPTION**

The UTC 22NM50 is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

FEATURES

- * $R_{DS(ON)} < 0.15\Omega$ @ $V_{GS}=10V$, $I_D=11A$
- * Fast Switching Capability
- * Avalanche Energy Specified
- * Improved dv/dt Capability, High Ruggedness

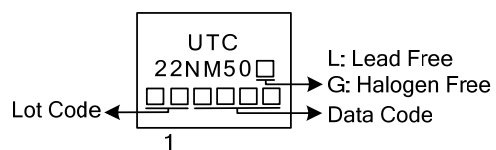
**SYMBOL****ORDERING INFORMATION**

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
22NM50L-TA3-T	22NM50G-TA3-T	TO-220	G	D	S	Tube
22NM50L-TF3-T	22NM50G-TF3-T	TO-220F	G	D	S	Tube
22NM50L-TF1-T	22NM50G-TF1-T	TO-220F1	G	D	S	Tube
22NM50L-TF2-T	22NM50G-TF2-T	TO-220F2	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source

22NM50L-TA3-T (1)Packing Type (2)Package Type (3)Green Package		(1) T: Tube (2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2 (3) L: Lead Free, G: Halogen Free and Lead Free
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■ MARKING



■ **ABSOLUTE MAXIMUM RATINGS** ($T_C=25^{\circ}\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DS}	500	V
Gate-Source Voltage		V_{GS}	± 30	V
Drain Current	Continuous	I_D	22	A
	Pulsed (Note 2)	I_{DM}	88	A
Avalanche Current (Note 2)		I_{AR}	9.9	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	833	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	8.6	V/ns
Power Dissipation	TO-220	P_D	235	W
	TO-220F/TO-220F1		390	W
	TO-220F2			
Junction Temperature		T_J	+150	$^{\circ}\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^{\circ}\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. $L = 17\text{mH}$, $I_{AS} = 9.9\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\Omega$, Starting $T_J = 25^{\circ}\text{C}$

4. $I_{SD} \leq 22\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^{\circ}\text{C}$

■ **THERMAL DATA**

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient		θ_{JA}	62.5	$^{\circ}\text{C}/\text{W}$
Junction to Case	TO-220	θ_{JC}	0.53	$^{\circ}\text{C}/\text{W}$
	TO-220F/TO-220F1		5.0	$^{\circ}\text{C}/\text{W}$
	TO-220F2			

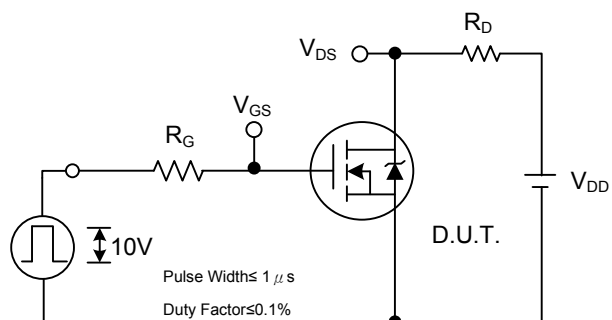
■ **ELECTRICAL CHARACTERISTICS** ($T_J = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	500			V
Drain-Source Leakage Current		I_{DSS}	$V_{DS}=500V, V_{GS}=0V$			50	μA
Gate- Source Leakage Current	Forward	I_{GSS}	$V_{DS}=0V, V_{GS}=+30V$			+100	nA
	Reverse		$V_{DS}=0V, V_{GS}=-30V$			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.5		4.5	V
Static Drain-Source On-Resistance		$R_{DS(ON)}$	$V_{GS}=10V, I_D=11A$			0.15	Ω
DYNAMIC PARAMETERS							
Input Capacitance		C_{ISS}	$V_{DS}=25V, V_{GS}=0V, f=1.0MHz$		1440		pF
Output Capacitance		C_{OSS}			1385		pF
Reverse Transfer Capacitance		C_{RSS}			119		pF
SWITCHING PARAMETERS							
Total Gate Charge (Note 1)		Q_G	$V_{DS}=50V, V_{GS}=10V, I_D=1.3A$ $I_G=100\mu A$ (Note1, 2)		159		nC
Gate to Source Charge		Q_{GS}			12		nC
Gate to Drain Charge		Q_{GD}			48		nC
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$	$V_{DS}=30V, V_{GS}=10V, I_D=0.5A,$ $R_G=25\Omega$ (Note1, 2)		70		ns
Rise Time		t_R			232		ns
Turn-OFF Delay Time		$t_{D(OFF)}$			360		ns
Fall-Time		t_F			327		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I_S				22	A
Maximum Body-Diode Pulsed Current		I_{SM}				88	A
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	$I_S=22A, V_{GS}=0V$			1.4	V
Body Diode Reverse Recovery Time (Note 1)		t_{rr}	$I_S=22A, V_{GS}=0V,$		450		ns
Body Diode Reverse Recovery Charge		Q_{rr}	$di_F/dt=100A/\mu s$		8.1		μC

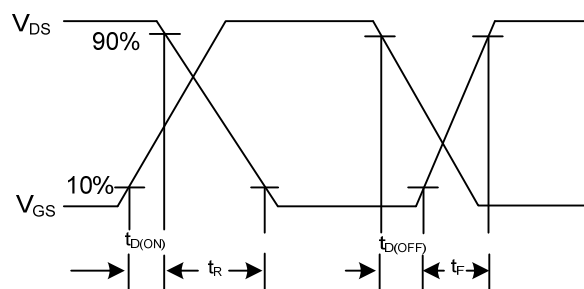
Notes: 1. Pulse Test : Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating ambient temperature.

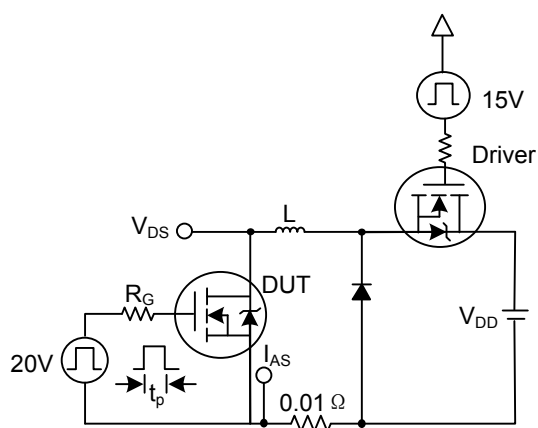
■ TEST CIRCUITS AND WAVEFORMS



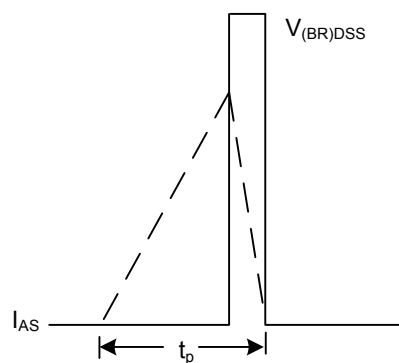
Switching Test Circuit



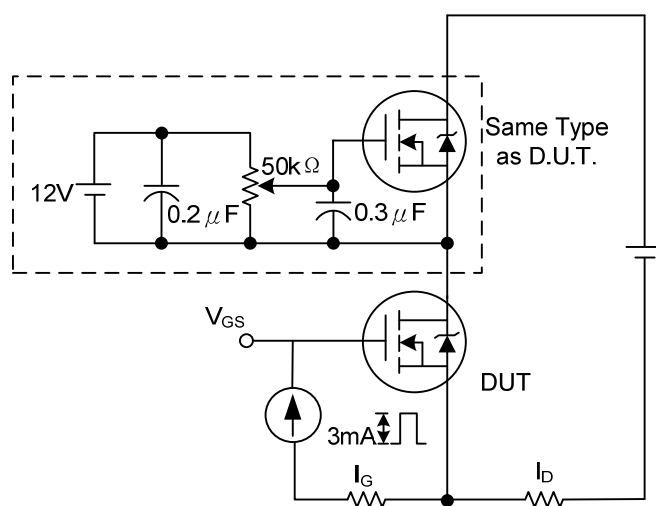
Switching Waveforms



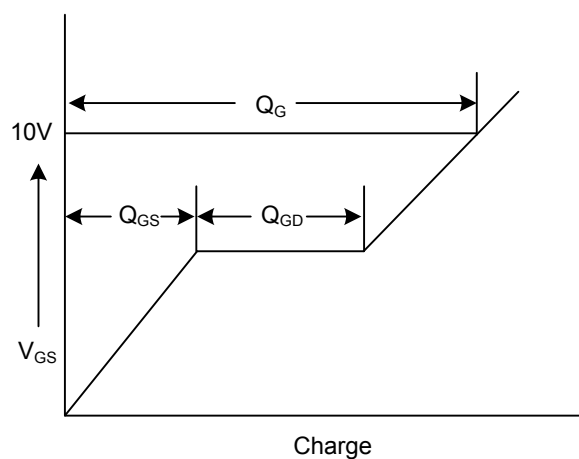
Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

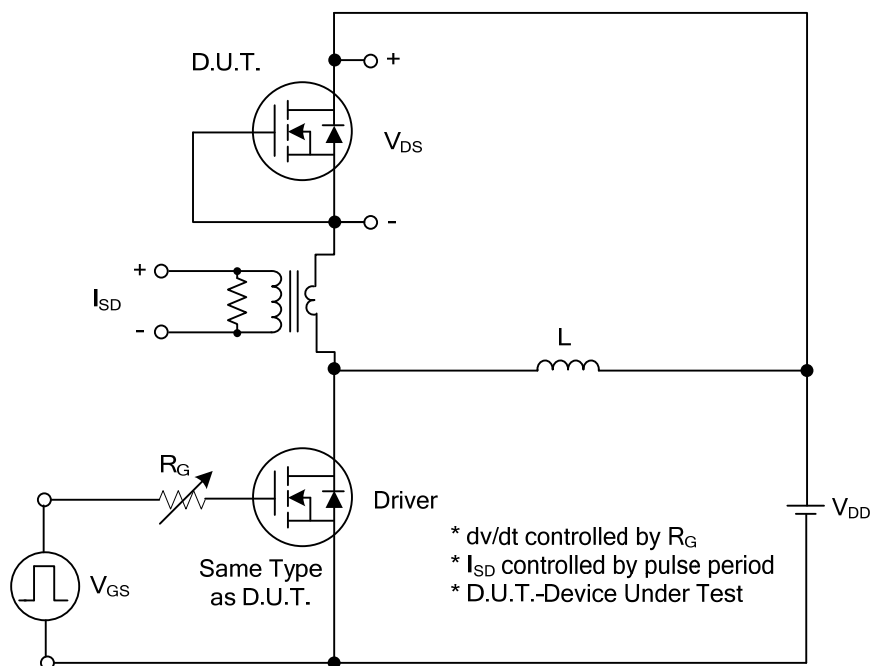


Gate Charge Test Circuit

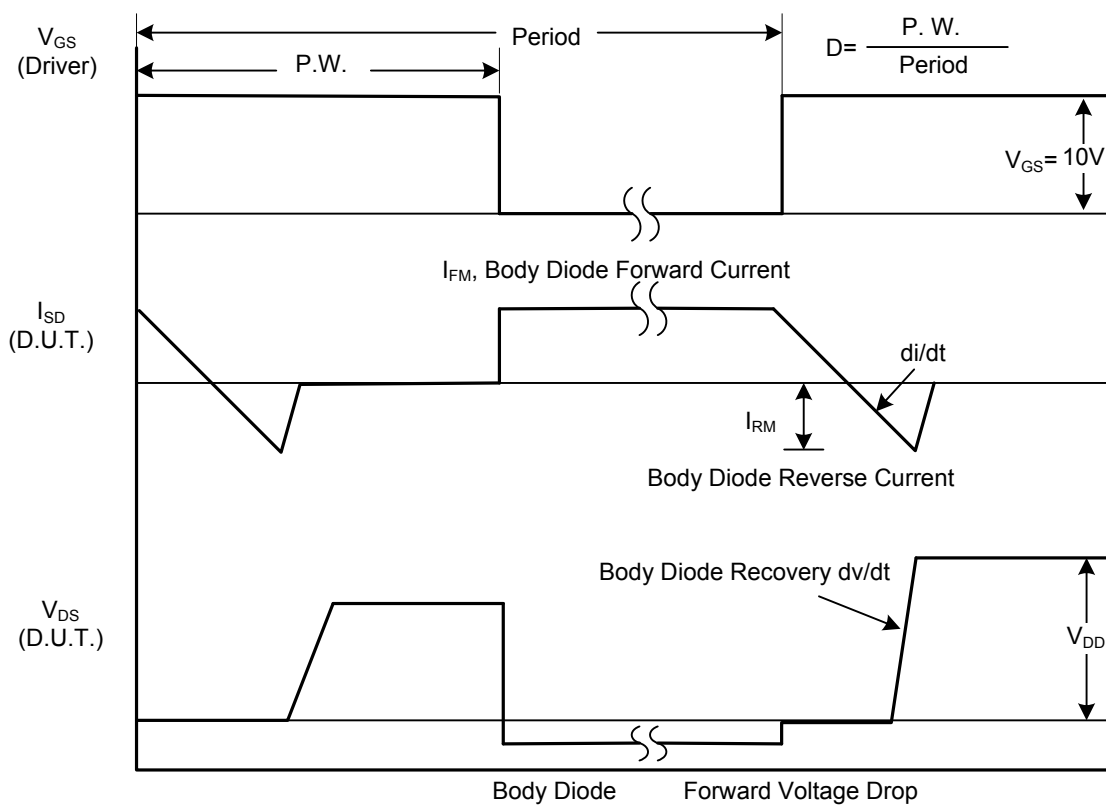


Gate Charge Waveform

■ TEST CIRCUITS AND WAVEFORMS



Peak Diode Recovery dv/dt Test Circuit



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